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General Information

Series	SMD Comm COG HV Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra-Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
Typical Component Weight	390 mg
Shelf Life	78 Weeks
MSL	1

Specifications

Capacitance	0.039 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	5%
Voltage DC	500 VDC
Dielectric Withstanding Voltage	750 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	25.641 GOhms

Dimensions	
L	5.9mm +/-0.75mm
W	6.4mm +/-0.4mm
T	2.5mm +/-0.20mm
S	3.2mm MIN
B	0.7mm +/-0.35mm
Case Code (EIA / mm)	2225 / 5663

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	500

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